

ESPI Current Report

Number: 3/2021
Date: 9 April 2021
Company: XTPL S.A., a joint stock company with its registered office in Wrocław

Topic:	The Issuer's project recommended for co-financing by the NCBiR
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Legal basis: Article 17(1) MAR – inside information

Contents of the Report: The Management Board of XTPL S.A. (the “Issuer”) announces that on 9 April 2021 it received information that the Issuer’s project “Development of breakthrough printing technology of 3D micrometric conductive structures using an innovative printhead capable of printing on non-planar substrates and compatible ink for printed electronics applications” (the “Project”) has been recommended for co-financing under the 6/1.1.1/2020 – “Fast Track” competition of the National Centre for Research and Development (“NCBiR”).

The scope of this project is the design and implementation of the new technology for printing of ultrafine conductive structures on 3D substrates for applications in printed electronics.

- Total Project value: PLN 11,615,569.56;
- Recommended co-financing value: PLN 7,695,844.09;
- Implementation period: 1 October 2020 – 30 September 2023

The final co-financing amount may change slightly at the stage of preparing the documentation for the grant agreement. The signing of the grant agreement will be communicated by the Issuer in a separate report.

In the opinion of the Issuer’s Management Board the above fact is inside information, as grants constitute an important part of financing the Issuer’s operations. The Project will contribute to further development of the Issuer’s strategic area of printed electronics.

Signatures of the Company’s representatives:

Jacek Olszański
MANAGEMENT BOARD MEMBER